

your BEST camera module partner

KLT-OV13850-L50B V2.0

OmniVision OV13850 MIPI Interfaccia Messa a fuoco automatica 13MP Modulo telecamera



Modulo telecamera n.	KLT-OV13850-L50B V2.0
Sensore d'immagine	OV13850
EFL	3.85 mm
F.NO	2.2
Pixel	4224 x 3136
Vista ad angolo	72.9°
Tipo di lente	1/3.06 pollice
Dimensioni dell'obiettivo	8.5 x 8.5 x 5.37 mm
Dimensione del modulo	17.9 x 9.00 mm
Tipo di modulo	Messa a fuoco automatica
Interfaccia	MIPI



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OV13850 13MP product brief



Power-Efficient 13-Megapixel Image Sensor with Best-In-Class Performance for High-End Smartphones and Tablets

The OV13850 is a high performance PureCel[™] 13-megapixel CameraChip[™] sensor that delivers best-in-class high- and low-light performance, as well as dramatically reduced power consumption for smartphones and tablets.

available in a lead-free package

> The OV13850 sensor offers a number of performance enhancements, including improved full-well capacity (FWC) and sensitivity for industry-leading high- and lowlight performance. It also offers a 40 percent reduction in power consumption compared to our previous generation sensor, making the OV13850 ideally suited for featurerich mobile devices.

The 1/3.06-inch OV13850 supports an active array of 4224 x 3136 pixels (13.2-megapixels) operating at 30 frames per second (fps) for zero shutter lag and can seamlessly transition between recording video and capturing still images. Additionally, the sensor supports 4K2K ultra-high definition video at 30 fps with full-horizontal field of view (FOV) and electronic image stabilization (EIS), as well as high frame rate 1080p HD video at 60 fps with EIS to enable high quality videos.

The OV13850 fits into an industry standard $8.5 \times 8.5 \times 5$ mm module.

Find out more at www.ovt.com.



Applications

- Cellular Phones
- Tablets

Product Features

- PureCel[™] image sensor
- 1.12 µm x 1.12 µm pixel
- optical size of 1/3.06"
- 31.2° CRA for <6 mm z-height
- programmable controls for frame rate, mirror and flip, cropping, and windowing
- support for image sizes:
 13.2MP (4224x3136),
 10MP (16:9 4224x2376),
 4K2K (3840x2160),
 EIS 1080p (2112x1188),
 EIS 720p (1408x792), and more
- 13.2MP at 30 fps
- two-wire serial bus control (SCCB)

strobe output to control flash

PC Multimedia

- 8 kbits of embedded one-time programmable (OTP) memory
- two on-chip phase lock loops (PLLs)
- programmable controls: gain, exposure, frame rate, image size, horizontal mirror, vertical flip, cropping, and panning
- image quality controls: defect pixel correction, automatic black level calibration, lens shading correction, and alternate row HDR
- built-in temperature sensor
- suitable for module size of 8.5 x 8.5 x <6 mm

Ordering Information

 OV13850-G04A (color, chip probing, 200 µm backgrinding, reconstructed wafer with good die)

Product Specifications

- active array size: 4224 x 3136
- power supply:
 core: 1.14 1.26V (1.2V nominal)
 analog: 2.6 3.0V (2.8V nominal)
 I/0: 1.7 3.0V (1.8V or 2.8V nominal)
- power requirements: - active: 223 mW - standby: 300 µW - XSHUTDOWN: 1 µW

 output interfaces: up to 4-lane MIPI serial output

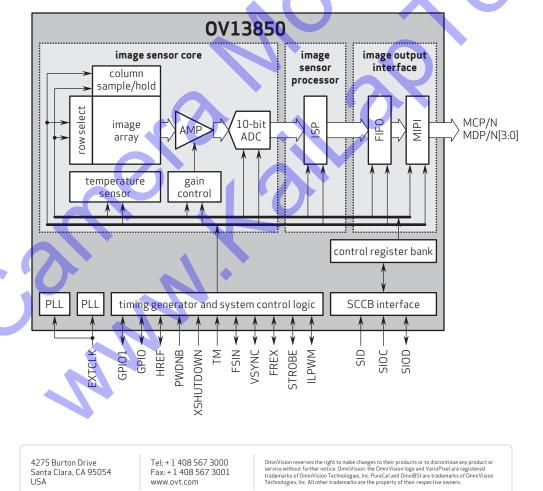
- temperature range:
 operating: -30°C to +85°C junction temperature
 stable image: 0°C to +60°C junction temperature
- lens size: 1/3.06"
 lens chief ray angle: 31.2°

output formats: 10-bit RGB RAW

OV13850

- input clock frequency: 6 64 MHz
- maximum image transfer rate: 30 fps
- scan mode: progressive
- pixel size: 1.12 µm x 1.12 µm
- image area: 4815 µm x 3678.3 µm
- die dimensions: 6210 μm x 5517 μm

Functional Block Diagram





Version 1.6, December, 2013